

# USB-UAPSTA-8801-U16-X86- W14.68.36.p178-CS4X14709\_R0-MGPL

88W8801 Release Notes



## Contents

Package Information .....	4
W14.68.36.p178-CS4X14709_R0-MGPL Information .....	4
Driver Version .....	4
Firmware Version .....	4
WLAN Features .....	5
Wireless Client Features[1x1 b/g/n] .....	5
802.11n - High Throughput - Infrastructure Mode .....	5
802.11 b/g Features .....	5
802.11d .....	5
802.11e -QoS .....	5
802.11i - Security .....	5
General Features .....	5
Power Save Modes .....	6
Loading Driver - Optional Parameters .....	6
WPS/WSC2.0 Functionality .....	6
WPA3 Support (Host MLME Enabled) .....	6
WPA3 Security - SAE (Simultaneous Authentication of Equals) .....	6
Access Point Features .....	7
802.11 a/b/g Features .....	7
802.11d .....	7
802.11e -QoS .....	7
802.11i - Security .....	7
Security WAPI .....	7
802.11n - High Throughput .....	7
WPA3 Support (Host MLME Enabled) .....	7
WPA3 Security - SAE (Simultaneous Authentication of Equals) .....	7
General Features .....	8
MMH Power Save Modes .....	8
Multi-BSS support .....	8
Loading Driver - Optional Parameters .....	8
WPS/WSC2.0 Functionality .....	8
Wifi Direct / P2P features .....	8
P2P Basic Functionality .....	8

---

P2P Backward Compatibility .....	9
P2P Client Power save .....	9
P2P GO Power save.....	9
Other P2P Features.....	9
Simultaneous AP-STA Operation .....	9
WLAN Throughput .....	10
STA Throughput .....	10
MMH Throughput .....	10
P2P Throughput .....	10
Bug Fixes/Feature Enhancements .....	11
Notes .....	12
Legal Information .....	13
Disclaimers.....	13
Trademarks .....	13

## Package Information

- Version: USB-UAPSTA-8801-U16-X86-W14.68.36.p178-CS4X14709\_R0-MGPL

### W14.68.36.p178-CS4X14709\_R0-MGPL Information

- SOC version – 88W8801 R0
- Firmware - W14.68.36.p178
  - usb8801\_uapsta.bin
- Driver Package - CS4X14709
- WPA supplicant : wpa\_supplicant-2.10
- Hostapd : hostapd-2.10
- Linux Kernel : 2.6.32 to 5.11.16

### Driver Version

- CS : Indicated Nxp OS independent driver
- 4.X : indicated support for kernel version 4.x
- **Release Number** : this number tracks the incremental changes in the consequent driver releases given to QA or customers.
- **Patch Number** : Customers may want to receive a driver build based on a previous release plus specific bug fixes, or patches. It is not unusual for customers to request this when they are close to production. The patch number starts at zero (no patch), and increments as we release subsequent builds with more bug fixes.

### Firmware Version

Following is an explanation of each digit in the versioning scheme designed for the firmware:

- “W” indicates the release includes the WPA/WPA2 VU, WPA Replay Protection Fixes required for WFA Security Detection/Certification testing purpose and Memory copy vulnerability fix.
- Major Revision (first number from the left): Tracks the main FW version.
- Minor Revision (second number from the left): Tracks the chip family, firmware branch, custom projects. etc.
- Release Number (third number from the left): this number tracks the incremental changes in the consequent firmware releases given to QA or customers.
- Patch Number (fourth number from the left): Customers may want to receive a firmware build based on a previous release plus specific bug fixes, or patches. It is not unusual for customers to request this when they are close to production. The patch number starts at zero (no patch), and increments as we release subsequent builds with more bug fixes.

## WLAN Features

### Wireless Client Features[1x1 b/g/n]

#### 802.11n - High Throughput - Infrastructure Mode

- 2.4GHz Band Operation
- 20MHz channel Bandwidth only
- Short/Long Guard Interval (400ns/800ns)
- Green Field Operation
- 1 Spatial stream (1x1)
- 11n Data rates – Up to 72 Mbps (MCS 0 to MCS 7)
- Tx MCS Rate Adaptation (ABGN)
- AMPDU Tx and Rx Support
- AMSDU-4k Tx and Rx Support
- AMSDU-8k – Only Rx Support
- HT Protection Mechanisms

#### 802.11 b/g Features

- Data Rates (Up to 54 Mbps)
- Tx Rate Adaptation (ABG)
- Tx of RTS/CTS based upon RTS Threshold
- Fragmentation/Defragmentation
- ERP protection, Slot time, Preamble
- ERP Protection using macctrl command (RTS-CTS/Self-CTS)

#### 802.11d

- 802.11d - Regulatory Domain/Operating Class/Country Info

#### 802.11e -QoS

- EDCA (Enhanced Distributed Channel Access) / WMM (Wireless Multi-Media)
- U-APSD[Unscheduled Automatic Power save and Delivery]/ WMM-Power save

#### 802.11i - Security

- Open and Shared Authentication
- WPA2-PSK Security (AES-CCMP Encryption)
- Opensource WPA Supplicant Support

### General Features

- Auto Deep Sleep
- Host Sleep (hscfg)
- Background Scan
- User Defined Scan (setuserscan)
- Specific scan (scancfg)
- Network Scan (iwlist scan)
- ARP Filter
- Subscriber Event
- Wakeup on Wireless (WoW)
- Auto Response (MEF)

- Auto Tx
- Vendor Specific IE (Custom IE)
- Broadcast/Multicast data Tx/Rx Support

#### Power Save Modes

- IEEE PS (Infrastructure Mode)
- PPS
- Inactivity Timeout
- Listen Interval

#### Loading Driver - Optional Parameters

- Configuring MAC Address during driver load using init\_cfg file
- Loading Driver Using CFG80211 and mlanutl commands
- Loading Driver Using WEXT
- Setting Deep sleep.

#### WPS/WSC2.0 Functionality

- PIN Config Method - 8 Digit/4 Digit
- PIN Config Method - Static/Dynamic PIN
- PBC - Virtual Push Button Config Method
- PBC Session Overlap Detection
- STA as Enrollee
- STA as Registrar
- Auto PIN
- Auto PBC
- Standalone ER
- Backward Compatibility with WPS1.0 Devices
- Using mwu\_cli app with Opensource WPA Supplicant

#### WPA3 Support (Host MLME Enabled)

- Opensource WPA Supplicant Support

#### WPA3 Security - SAE (Simultaneous Authentication of Equals)

- SAE Connectivity and PMK Caching
- SAE Transition Mode
- Anti-Clogging
- SAE Finite Cyclic Group - Group-19, Group 20, Group-21
- Reflection Attack
- WPA2 Personal Compatibility

## Access Point Features

### 802.11 a/b/g Features

- Data Rates (Up to 54 Mbps)
- Tx Rate Adaptation (ABG)
- Tx of RTS/CTS based upon RTS Threshold
- Fragmentation/Defragmentation
- ERP protection, Slot time, Preamble
- Handling Associated STAs with IEEE PS - PS-Poll and Null Data

### 802.11d

- 802.11d - Regulatory Domain/Operating Class/Country Info

### 802.11e -QoS

- EDCA[Enhanced Distributed Channel Access] / WMM (Wireless Multi-Media)
- U-APSD[Unscheduled Automatic Power save and Delivery]/ WMM-Power save

### 802.11i - Security

- Open and Shared Authentication
- Auto Auth
- WPA2-PSK Security (AES-CCMP Encryption)
- Opensource Host based Authenticator Support (Hostapd)
- Group Key Refresh (Rekeying GTK)

### Security WAPI

- WAPI-PSK
- WAPI-CERT
- WAPI-PKCS12

### 802.11n - High Throughput

- 2.4GHz Band Operation
- 20 MHz channel Bandwidth only
- Short/Long Guard Interval (400ns/800ns)
- Green Field Operation
- 1 Spatial stream (1x1)
- 11n Data rates – Up to 72 Mbps (MCS 0 to MCS 07)
- Tx MCS Rate Adaptation (ABGN)
- AMPDU Tx and Rx Support
- AMSDU 4K Tx/Rx Support
- AMSDU-8k Rx Support
- HT Protection Mechanisms

### WPA3 Support (Host MLME Enabled)

- Opensource WPA Supplicant Support

### WPA3 Security - SAE (Simultaneous Authentication of Equals)

- SAE Connectivity and PMK Caching
- SAE Transition Mode
- Anti-Clogging
- SAE Finite Cyclic Group - Group-19, Group 20, Group-21

- Reflection Attack
- WPA2 Personal Compatibility

#### General Features

- Auto Deep Sleep
- Host Sleep (hscfg)
- Automatic Channel Selection (ACS)
- Hidden SSID (Broadcast SSID Disabled)
- MAC Address Filter (Allowed/Denied List)
- Vendor Specific IE (Custom IE)
- STA Age out Feature for non-PS clients
- STA Age out Feature for Power save clients
- Configurable MAX Supported Stations (Up to 8)
- Configurable Retry Limit
- Configurable Unicast Data Rate
- Configurable Broadcast/Multicast Data Rate
- Broadcast/Multicast data Tx/Rx Support
- MMH Events
- BSS Privacy Control (Packet forward Control) or AP Isolation
- Sticky TIM

#### MMH Power Save Modes

- Inactivity based Power save

#### Multi-BSS support

- MAX MMH BSS = 2
- Independent security configurations on different interfaces (All Security Methods)

#### Loading Driver - Optional Parameters

- Configuring MAC Address during driver load using init\_cfg file
- Loading Driver Using CFG80211 and mlanutl commands
- Loading Driver Using WEXT
- Setting Deepsleep
- Loading MMH configuration using uaputl.conf file

#### WPS/WSC2.0 Functionality

- PIN Config Method - 8 Digit/4 Digit
- PIN Config Method - Static/Dynamic PIN
- PBC - Virtual Push Button Config Method
- AP Setup Locked State - PIN Method
- PBC Session Overlap Detection
- MMH as Enrollee
- MMH as Wireless Registrar
- MMH as Wired ER (Bridging uap0 and eth interfaces)
- MMH as Proxy - Configuration by ER and Adding an Enrollee (UPnP)
- Using mwu\_cli app

#### Wifi Direct / P2P features

##### P2P Basic Functionality

##### Release notes

**COMPANY CONFIDENTIAL**



- Protocol conformance tests
- Autonomous GO Mode
- WFD Client Mode

#### P2P Backward Compatibility

- Non P2P Client Association with GO

#### P2P Client Power save

- P2P Client with IEEE Power save enabled
- P2P Client with WMM PS enabled
- P2P Client with NoA PS enabled on GO
- P2P Client with Opportunistic PS enabled on GO

#### P2P GO Power save

- GO Operating with IEEE PS Clients(PS-Poll and non\_PS-Poll)
- GO Operating with WMM PS Clients

#### Other P2P Features

- Max Client Support (Up to 7 Devices)
- Provision Discovery
- Persistent Group
- P2P Invitation

#### Simultaneous AP-STA Operation

- AP-STA functionality.
- Enhanced Power Save (AP-STA simultaneous power save)

## WLAN Throughput

### STA Throughput

STA Infra Throughput - BGN Mode   2.4GHz Band				
AMPDU Throughput				
Security	HT20			
	TCP		UDP	
	Tx	Rx	Tx	Rx
OPEN	41.4	57.5	53.0	60.2
WPA2	43.7	56.8	52.1	59.1
WPA3	41.7	57.0	52.1	58.7

### MMH Throughput

MMH Throughput - BGN Mode   2.4GHz Band				
AMPDU Throughput				
Security	20MHz			
	TCP		UDP	
	Tx	Rx	Tx	Rx
OPEN	42.0	51.0	45.8	55.0
WPA2	40.2	51.0	47.1	55.0
WPA3	40.4	51.0	50.0	55.0

### P2P Throughput

P2P(GO) Throughput - BGN Mode   2.4GHz Band				
AMPDU Throughput				
Security	HT20			
	TCP		UDP	
	Tx	Rx	Tx	Rx
WPA2	40.0	45.0	47.4	48.0

## Bug Fixes/Feature Enhancements

Component	Description
Wi-Fi	<ul style="list-style-type: none"><li>• Fix for DUT connection issue with WPA2 AP at the first attempt when set to host_mlme=1</li><li>• Fix for Command timeout issue due to scan failure with edmac enabled.</li><li>• Code enhancement to avoid Deadlock scenario in driver for locking mechanism</li><li>• Fix for source code static program analysis error</li><li>• Improvement on FW Download time</li><li>• Added logic to initiate additional scan before Auth process if Ex-AP is not in scan list, applicable to host_mlme=1</li></ul>

## Notes

- Simultaneous AP-STA Limitations:
  - MMH BSS beacons are paused unconditionally whenever In-STA Performs scan and are resumed automatically once the scan is complete.
  - TX power settings, Radio control commands, Antenna config commands, wireless slot, 802.11d are not unified across MMH and In-STA interfaces
  - Custom IE Buffers are shared between two interfaces (uap0 and wlan0). IE\_Buffer Index used by one interface cannot be used by other interface.
  - Notes:
    - Ex-AP - External AP (AP to which wlan0 interface is associated)
    - In-STA - Internal Station (wlan0 interface)
    - Ex-STA - External Stations associates to MMH.
    - uAP - Micro AP/ MMH – (Marvell Mobile Hotspot)
- Multi-BSS (MBSS) Limitations:
  - TX power settings, Radio control commands, Antenna config commands, wireless slot, 802.11d are not unified across two interfaces.
  - Custom IE Buffers are shared between two interfaces. IE\_Buffer Index used by one interface cannot be used by other interface.
- The driver needs to be loaded with “low\_power\_mode\_enable=1” to enable low power mode.  
Usage: insmod sd8xxx.ko low\_power\_mode\_enable=1

## Legal Information

### Disclaimers

**Limited warranty and liability** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors. In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory. Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of NXP Semiconductors.

**Right to make changes** — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification. Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products. NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Evaluation products** — This product is provided on an "as is" and "with all faults" basis for evaluation purposes only. NXP Semiconductors, its affiliates and their suppliers expressly disclaim all warranties, whether express, implied or statutory, including but not limited to the implied warranties of non-infringement, merchantability and fitness for a particular purpose. The entire risk as to the quality, or arising out of the use or performance, of this product remains with customer. In no event shall NXP Semiconductors, its affiliates or their suppliers be liable to customer for any special, indirect, consequential, punitive or incidental damages (including without limitation damages for loss of business, business interruption, loss of use, loss of data or information, and the like) arising out of the use of or inability to use the product, whether or not based on tort (including negligence), strict liability, breach of contract, breach of warranty or any other theory, even if advised of the possibility of such damages. Notwithstanding any damages that customer might incur for any reason whatsoever (including without limitation, all damages

referenced above and all direct or general damages), the entire liability of NXP Semiconductors, its affiliates and their suppliers and customer's exclusive remedy for all of the foregoing shall be limited to actual damages incurred by customer based on reasonable reliance up to the greater of the amount actually paid by customer for the product or five dollars (US\$5.00). The foregoing limitations, exclusions and disclaimers shall apply to the maximum extent permitted by applicable law, even if any remedy fails of its essential purpose.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

### Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.